

IGBT SIP Module (Fast IGBT)



PRODUCT SUMMARY

| OUTPUT CURRENT IN A TYPICAL 5.0 kHz MOTOR DRIVE | | | | | | |
|---|----------------------|--|--|--|--|--|
| V _{CES} | 600 V | | | | | |
| I_{RMS} per phase (3.1 kW total) with T _C = 90 °C | 11 A | | | | | |
| TJ | 125 °C | | | | | |
| Supply voltage | 360 V _{DC} | | | | | |
| Power factor | 0.8 | | | | | |
| Modulation depth See fig. 1 | 115 % | | | | | |
| $V_{CE(on)}$ (typical) at I _C = 4.8 A, 25 °C | 1.41 V | | | | | |
| Speed | 1 kHz to 8 kHz | | | | | |
| Package | SIP | | | | | |
| Circuit | Three phase inverter | | | | | |

FEATURES

- Fully isolated printed circuit board mount package
- Switching-loss rating includes all "tail" losses
- HEXFRED[®] soft ultrafast diodes
- Optimized for medium speed, see fig. 1 for current vs. frequency curve
- Designed and qualified for industrial level
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The IGBT technology is the key to the advanced line of IMS (Insulated Metal Substrate) power modules. These modules are more efficient than comparable bipolar transistor modules, while at the same time having the simpler gate-drive requirements of the familiar power MOSFET. This superior technology has now been coupled to a state of the art materials system that maximizes power throughput with low thermal resistance. This package is highly suited to motor drive applications and where space is at a premium.

| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | |
|--|-----------------------------------|---|---------------------------------|---------------------|--|
| Collector to emitter voltage | V _{CES} | | 600 | V | |
| Continuous collector current, each | 1 | T _C = 25 °C | 8.8 | | |
| IGBT | Ι _C | T _C = 100 °C | 4.8 | | |
| Pulsed collector current | I _{CM} | Repetitive rating; $V_{GE} = 20 V$, pulse width limited by maximum junction temperature. See fig. 20 | 26 | A | |
| Clamped inductive load current | I _{LM} | | 800 | | |
| Diode continuous forward current | l _F | T _C = 100 °C 3.4 | | | |
| Diode maximum forward current | I _{FM} | | 26 | | |
| Gate to emitter voltage | V _{GE} | | ± 20 | V | |
| Isolation voltage | V _{ISOL} | Any terminal to case, t = 1 min | 2500 | V _{RMS} | |
| Maximum power dissipation, each | | T _C = 25 °C | 23 | 14/ | |
| IGBT | PD | T _C = 100 °C | 9.1 | W | |
| Operating junction and storage temperature range | T _J , T _{Stg} | | -40 to +150 | °C | |
| Soldering temperature | | For 10 s | 300 (0.063" (1.6 mm) from case) | | |
| Mounting torque | | 6-32 or M3 screw | 5 to 7 (0.55 to 0.8) | lbf · in (N · m) | |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | |
|---|----------------------------|----------|------|---------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNITS | |
| Junction to case, each IGBT, one IGBT in conduction | R _{thJC} (IGBT) | - | 5.5 | | |
| Junction to case, each diode, one diode in conduction | R _{thJC} (diode) | - | 9.0 | °C/W | |
| Case to sink, flat, greased surface | R _{thCS} (module) | 0.1 | - | | |
| Weight of module | | 20 (0.7) | - | g (oz.) | |

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| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|-----------------------------------|--|---|------|------|-------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage | V _{(BR)CES} | V_{GE} = 0 V, I_C = 250 μA Pulse width \leq 80 $\mu s,$ duty factor \leq 0.1 % | | 600 | - | - | V |
| Temperature coeff. of breakdown voltage | $\Delta V_{(BR)CES} / \Delta T_J$ | $V_{GE} = 0 \text{ V}, I_{C} = 1.0 \text{ mA}$ | | - | 0.72 | - | V/°C |
| | | I _C = 4.8 A | | - | 1.41 | 1.7 | - V |
| Collector to emitter saturation voltage | V _{CE(on)} | I _C = 8.8 A | V _{GE} = 15 V See fig. 2, 5 | - | 1.66 | - | |
| | | I _C = 4.8 A, T _J = 150 °C | 000 lig. 2, 0 | - | 1.42 | - | |
| Gate threshold voltage | V _{GE(th)} | $V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$ | 3.0 | - | 6.0 | | |
| Gate to emitter leakage current | I _{GES} | $V_{GE} = \pm 20 \text{ V}$ | | - | - | ± 100 | nA |
| Temperature coeff. of threshold voltage | $\Delta V_{GE(th)} / \Delta T_J$ | $V_{GE} = 0 \text{ V}, \text{ I}_{C} = 1.0 \text{ mA}$ | | - | -11 | - | mV/°C |
| Forward transconductance | 9 _{fe} | V_{CE} = 100 V, I _C = 4.8 A Pulse width 5.0 µs; single shot | | 2.9 | 5.0 | - | S |
| Zero gate voltage collector current | | $V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$ | | - | - | 250 | μA |
| | 010 | V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150 $^{\circ}C$ | | - | - | 1700 | |
| | N/ | $ I_{C} = 8.0 \text{ A} \\ I_{C} = 8.0 \text{ A}, \text{T}_{\text{J}} = 150 ^{\circ}\text{C} $ | Section 10 | - | 1.4 | 1.7 | v |
| Diode forward voltage drop | V _{FM} | | See lig. 13 | - | 1.3 | 1.6 | v |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS | |
|--|--------------------------|--|--|--|------|------|-------|----------|
| Total gate charge (turn on) | Qg | $I_{\rm C} = 4.8 {\rm A}$ | | - | 30 | 45 | | |
| Gate to emitter charge (turn on) | Q _{ge} | V _{CC} = 400 V | 0 | | - | 4.0 | 6.0 | nC |
| Gate to collector charge | Q _{gc} | See fig. 8 | | | - | 13 | 20 | |
| Turn-on delay time | t _{d(on)} | | | | - | 49 | - | 1 |
| Rise time | t _r | T.I = 25 °C | T 25 °C | | | 22 | - | |
| Turn-off delay time | t _{d(off)} | $I_{\rm C} = 4.8 {\rm A}, {\rm V}_{\rm C}$ | _{CC} = 480 V | | - | 200 | 300 | ms mJ |
| Fall time | t _f | V _{GE} = 15 V, I | R _G = 50 Ω es include "tai | l" and | - | 214 | 320 | |
| Turn-on switching loss | Eon | diode revers | ev recovery. | | - | 0.23 | - | |
| Turn-off switching loss | E _{off} | See fig. 9, 10 | D, 18 | | - | 0.33 | - | |
| Total switching loss | E _{ts} | | | | | 0.45 | 0.70 | 1 |
| Turn-on delay time | t _{d(on)} | $\begin{array}{l} T_J = 150 \ ^\circ C, \\ I_C = 4.8 \ \text{A}, \ V_{CC} = 480 \ \text{V} \\ V_{GE} = 15 \ \text{V}, \ R_G = 50 \ \Omega \\ \text{Energy losses include "tail" and} \\ \text{diode reverse recovery} \\ \text{See fig. 10, 11, 18} \end{array}$ | | | - | 48 | - | ns |
| Rise time | t _r | | | | - | 25 | - | |
| Turn-off delay time | t _{d(off)} | | | | - | 435 | - | |
| Fall time | t _f | | | | - | 364 | - | |
| Total switching loss | E _{ts} | | | | - | 0.93 | - | mJ |
| Input capacitance | Cies | $V_{GE} = 0 V$ $V_{CC} = 30 V$ See fig. 7 | | | - | 340 | - | pF |
| Output capacitance | Coes | | | See fig. 7 | - | 63 | - | |
| Reverse transfer capacitance | C _{res} | | | | - | 5.9 | - | 1 |
| Diada reverse recevery time | | T _J = 25 °C | See fig. 14 | | - | 37 | 55 | |
| Diode reverse recovery time | t _{rr} | T _J = 125 °C See | | | - | 55 | 90 | ns |
| | 1 | T _J = 25 °C | | - | 3.5 | 50 | ^ | |
| Diode peak reverse recovery current | I _{rr} | T _J = 125 °C | 125 °C See fig. 15 | I _F = 8.0 A V _B = 200 V | - | 4.5 | 8.0 | A |
| | 0 | | dl/dt = 200 A/us | - | 65 | 138 | nC | |
| Diode reverse recovery charge | Q _{rr} | | | - | 124 | 360 | | |
| | $T_J = 25 \text{ °C}$ | | - | 240 | - | A / | | |
| Diode peak rate of fall of recovery during t_b | dl _{(rec)M} /dt | dt $T_J = 125 ^{\circ}\text{C}$ See fig. 17 | | | - | 210 | - | A/µs |

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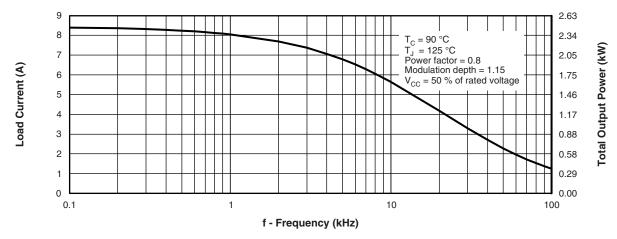
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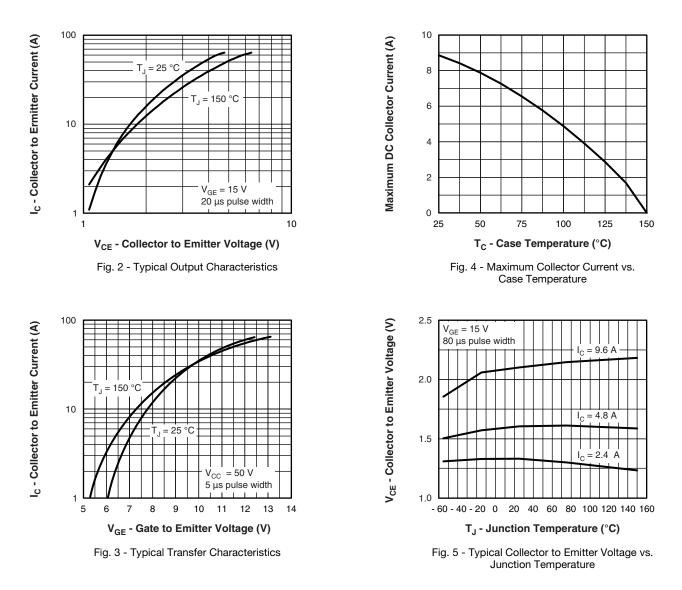
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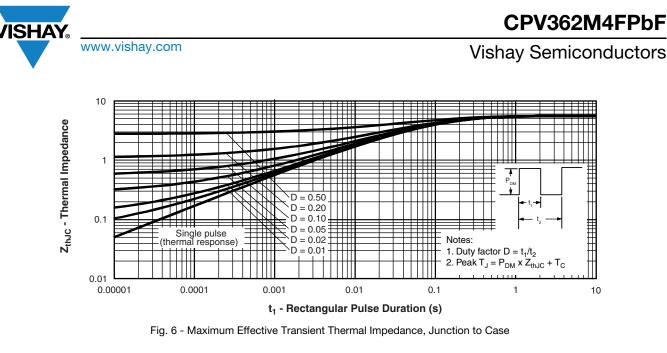


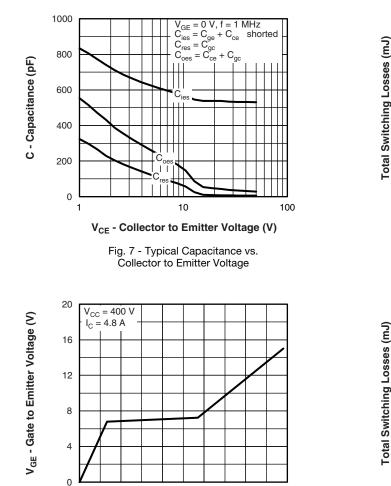
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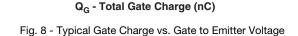
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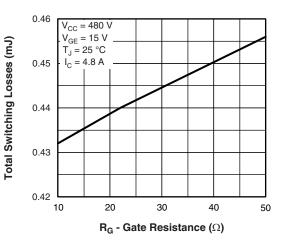
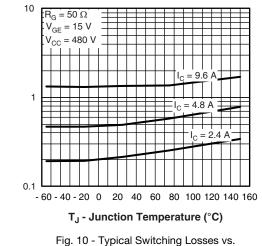


Fig. 9 - Typical Switching Losses vs. Gate Resistance



Junction Temperature

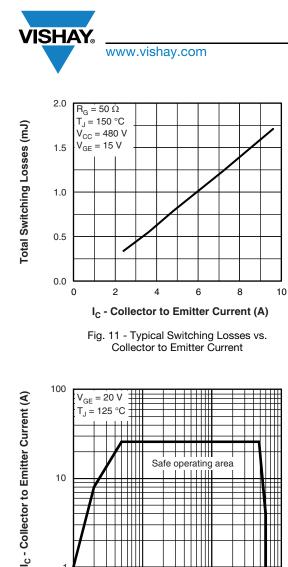
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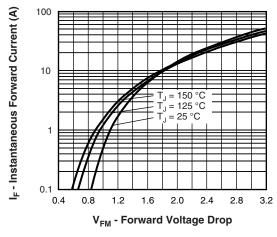
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V_{CE} - Collector to Emitter Voltage (V) Fig. 12 - Turn-Off SOA

100

1000

Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

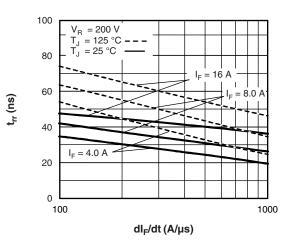


Fig. 14 - Typical Reverse Recovery Time vs. dl_F/dt

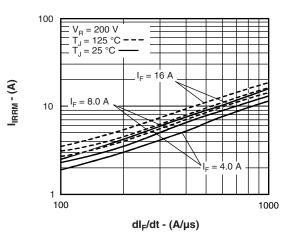


Fig. 15 - Typical Recovery Current vs. dl_F/dt

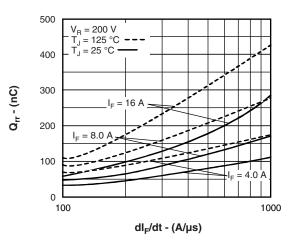


Fig. 16 - Typical Stored Charge vs. dl_F/dt

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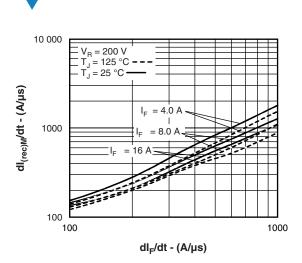
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Fig. 17 - Typical dl_{(REC)M}/dt vs dl_F/dt

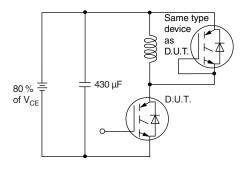


Fig. 18a - Test Circuit for Measurement of I_LM, E_on, E_{off(diode)}, t_{rr}, Q_{rr}, I_{rr}, t_{d(on)}, t_r, t_{d(off)}, t_f

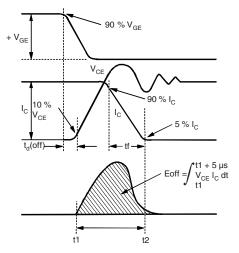


Fig. 18b - Test Waveforms of Circuit of Fig. 18a, Defining $E_{\text{off}},\,t_{\text{d(off)}},\,t_{\text{f}}$

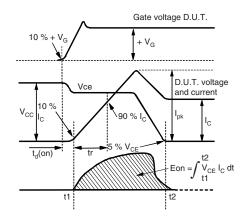


Fig. 18c - Test Waveforms of Circuit of Fig. 18a, Defining $E_{\text{on}},\,t_{d(\text{on})},\,t_{r}$

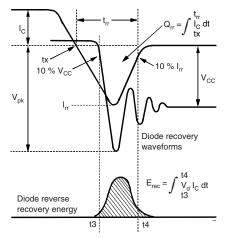


Fig. 18d - Test Waveforms of Circuit of Fig. 18a, Defining $\mathsf{E}_{\mathsf{rec}},\,\mathsf{t}_{\mathsf{rr}},\,\mathsf{Q}_{\mathsf{rr}},\,\mathsf{I}_{\mathsf{rr}}$

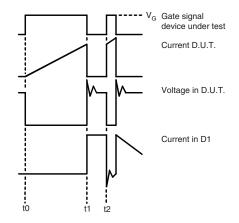


Fig. 18e - Macro Waveforms for Figure 18a's Test Circuit

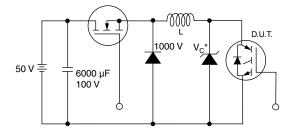
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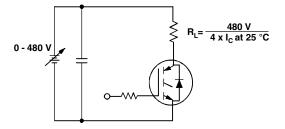
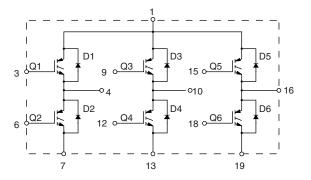


Fig. 19 - Clamped Inductive Load Test Circuit

Fig. 20 - Pulsed Collector Current Test Circuit

CIRCUIT CONFIGURATION

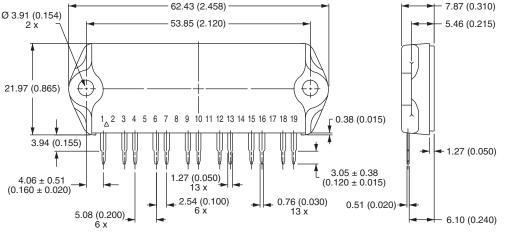


| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95066 | | | |



IMS-2 (SIP)

DIMENSIONS in millimeters (inches)



IMS-2 Package Outline (13 Pins)

Notes

- $^{(1)}$ Tolerance uless otherwise specified \pm 0.254 mm (0.010")
- ⁽²⁾ Controlling dimension: inch
- ⁽³⁾ Terminal numbers are shown for reference only



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